

2SK1573 Silicon N Channel MOS FET

REJ03G0955-0200 (Previous: ADE-208-1295) Rev.2.00 Sep 07, 2005

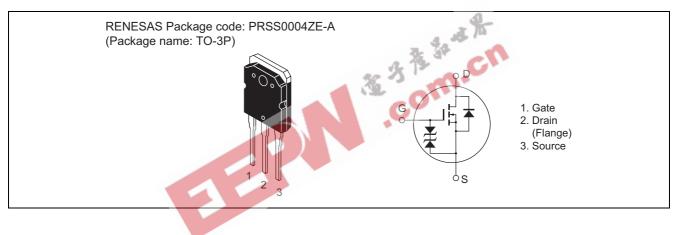
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

Outline





Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	600	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	I _D	15	А
Drain peak current	I _{D(pulse)} *1	60	А
Body to drain diode reverse drain current	I _{DR}	15	А
Channel dissipation	Pch ^{*2}	125	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at $T_C = 25^{\circ}C$

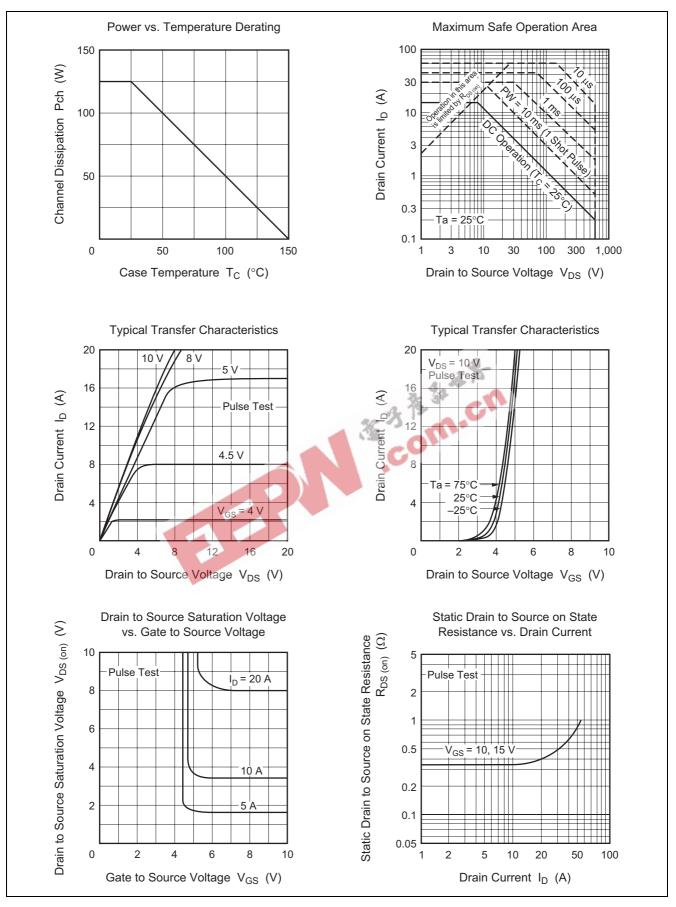
Electrical Characteristics

						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	V _{(BR)DSS}	600	_	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V _{(BR)GSS}	±30	_	—	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}		-	±10	μΑ	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}			250	μΑ	$V_{DS} = 500 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	2.0	-	3.0	V	$I_{D} = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state	R _{DS(on)}	_	0.35	0.50	Ω	$I_{\rm D} = 8 \text{ A}, \text{ V}_{\rm GS} = 10 \text{ V}^{*3}$
resistance			- 36	3		
Forward transfer admittance	y _{fs}	9	14	- -	S	$I_D = 8 \text{ A}, V_{DS} = 10 \text{ V}^{*3}$
Input capacitance	Ciss		31 50	6	pF	$V_{DS} = 10 V, V_{GS} = 0,$
Output capacitance	Coss	t -	700	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	4	90	—	pF	
Turn-on delay time	t _{d(on)}		35	—	ns	$I_D = 8 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time	tr	-	105	—	ns	$R_L = 3.75 \Omega$
Turn-off delay time	t _{d(off)}		250	—	ns	
Fall time	t _f	_	90	—	ns	
Body to drain diode forward voltage	V _{DF}	_	1.0	—	V	I _F = 15 A, V _{GS} = 0
Body to drain diode reverse recovery	t _{rr}	_	680	—	ns	$I_F = 15 \text{ A}, V_{GS} = 0,$
time						di _F /dt = 100 A/μs

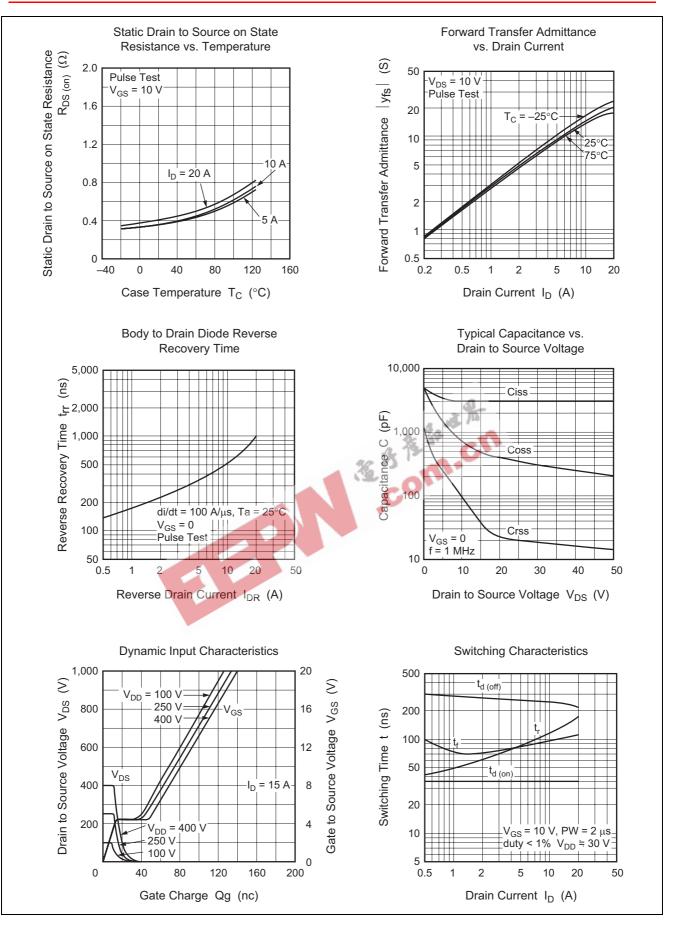
Note: 3. Pulse test



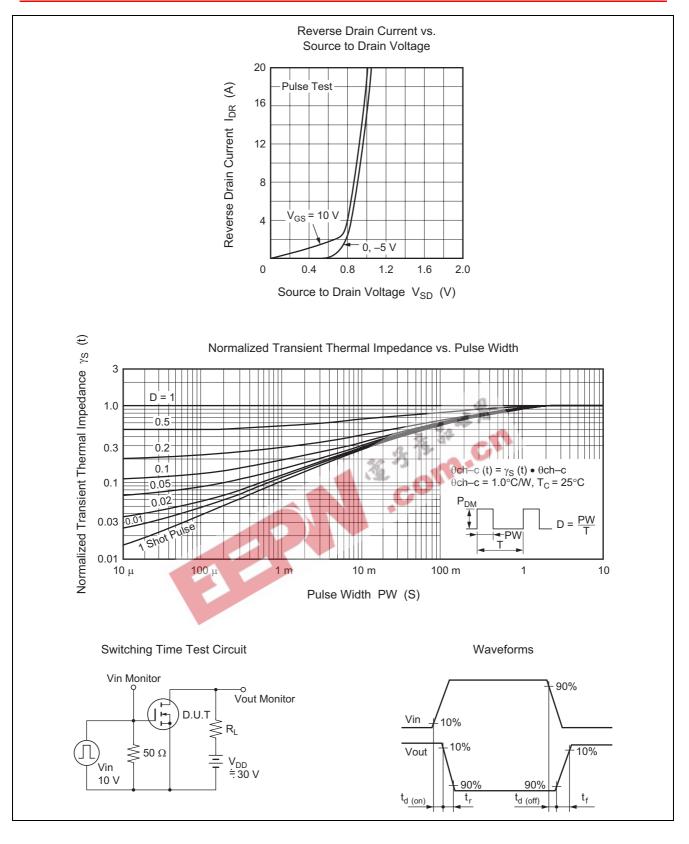
Main Characteristics





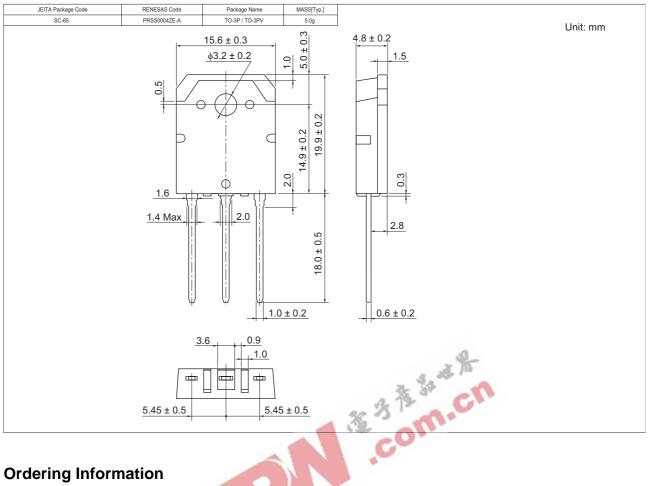








Package Dimensions



Part Name	Q	uantity	Shipping Container
2SK1573-E	360 pcs		Box (Tube)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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